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- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These octal buffers/drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. When these devices are used with the 'ALS241, 'AS241A, 'ALS244, and 'AS244A, the circuit designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (\overline{OE}) inputs, and complementary OE and \overline{OE} inputs. These devices feature high fan-out and improved fan-in.

The -1 version of SN74ALS240A is identical to the standard version, except that the recommended maximum I_{OL} for the -1 version is 48 mA. There is no -1 version of the SN54ALS240A.

The SN54ALS240A and SN54AS240A are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS240A and SN74AS240A are characterized for operation from 0°C to 70°C.

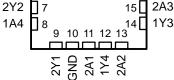
SN54ALS240A, SN54AS240A J PACKAGE
SN74ALS240A, SN74AS240A DW OR N PACKAGE
(TOP VIEW)

SN54ALS240A, SN54AS240A . . . FK PACKAGE

1A2

2Y3

1A3



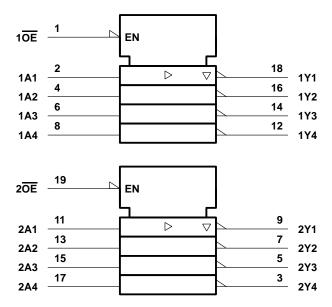
FUNCTION TABLE	
(each buffer)	

	•	,
INP	JTS	OUTPUT
OE	Α	Y
L	Н	L
L	L	н
н	х	Z

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

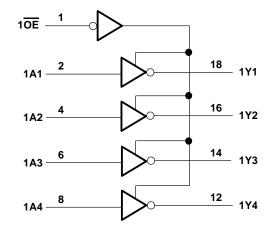
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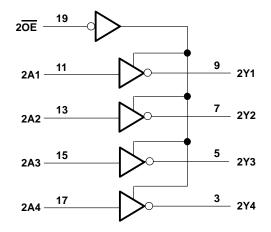
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Input voltage, V _I	
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54ALS240A	-55°C to 125°C
SN74ALS240A	0°C to 70°C
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



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recommended operating conditions

		SN54ALS240A		SN7	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ЮН	High-level output current			-12			-15	mA
				12			24	mA
^I OL	Low-level output current						48†	IIIA
TA	Operating free-air temperature	-55		125	0		70	°C

[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST O	TEST CONDITIONS			SN54ALS240A		74ALS24	0A	
PARAMETER	TEST G	UNDITIONS	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 V \text{ to } 5.5 V,$	I _{OH} = -0.4 mA	V _{CC} -2	2		V _{CC} -2	2		
Vari		I _{OH} = -3 mA	2.4	3.2		2.4	3.2		v
VOH	$V_{CC} = 4.5 V$	I _{OH} = -12 mA	2						v
		I _{OH} = -15 mA				2			
		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL	$V_{CC} = 4.5 V$	I _{OL} = 24 mA					0.35	0.5	V
		$I_{OL} = 48 \text{ mA}^{\dagger}$					0.35	0.5	
IOZH	$V_{CC} = 5.5 V,$	V _O = 2.7 V			20			20	μΑ
IOZL	$V_{CC} = 5.5 V,$	V _O = 0.4 V			-20			-20	μΑ
II	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
IIН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA
١	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA
۱ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
		Outputs high		4	11		4	11	
ICC	V _{CC} = 5.5 V	Outputs low		13	23		13	23	mA
		Outputs disabled		14	25		14	25	

 † Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	$\label{eq:constraint} \begin{array}{c} V_{CC} = 4.5 \ V \ to \ 5.5 \ V, \\ C_L = 50 \ pF, \\ R1 = 500 \ \Omega, \\ TO \\ (OUTPUT) \\ T_A = MIN \ to \ MAX^{\dagger} \end{array}$					UNIT
		SN54ALS240A SN74				S240A	
			MIN	MAX	MIN	MAX	
^t PLH	A	v	2	22	2	9	ns
^t PHL		Ŷ	2	11	2	9	115
^t PZH	ŌĒ	Y	4	34	5	13	ns
tPZL		Ŷ	5	26	5	18	115
^t PHZ	OE	v	1	15	2	10	
^t PLZ			3	24	3	12	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted) ‡

Supply voltage, V _{CC}	
Input voltage, V ₁	7 V
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54AS240A	-55°C to 125°C
SN74AS240A	0°C to 70°C
Storage temperature range	-65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS240A			SN	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
$V_{ L}$	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-12			-15	mA
IOL	Low-level output current	48				64	mA	
TA	Operating free-air temperature	-55		125	0		70	°C



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DADAMETER	TEOTO	TEST CONDITIONS			SN54AS240A		74AS24	DA	UNIT	
PARAMETER	IESIC	UNDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
VIK	V _{CC} = 4.5 V,	lj = –18 mA			-1.2			-1.2	V	
	V _{CC} = 4.5 V to 5.5 V	I _{OH} = -2 mA	V _{CC} -2	2		V _{CC} -2	2			
Veri	VCC = 4.5 V 10 5.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.4		2.4	3.4		v	
VOH		I _{OH} = -12 mA	2.4						v	
	$V_{CC} = 4.5 V$	I _{OH} = -15 mA				2.4				
Ve		I _{OL} = 48 mA		0.27	0.55			v		
VOL	$V_{CC} = 4.5 V$	I _{OL} = 64 mA					0.31	0.55	V	
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			50			50	μA	
IOZL	V _{CC} = 5.5 V,	V _O = 0.4 V			-50			-50	μA	
l	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
Ін	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA	
A inputs					-1			-1	A	
IIL OE inputs	$V_{CC} = 5.5 V,$	VI ='U!4' v			-0.5			-0.5	mA	
IO [‡]	V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	-50		-150	mA	
		Outputs high		11	17		11	17		
ICC	V _{CC} = 5.5 V	Outputs low		51	75		51	75	mA	
		Outputs disabled		24	38		24	38		

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

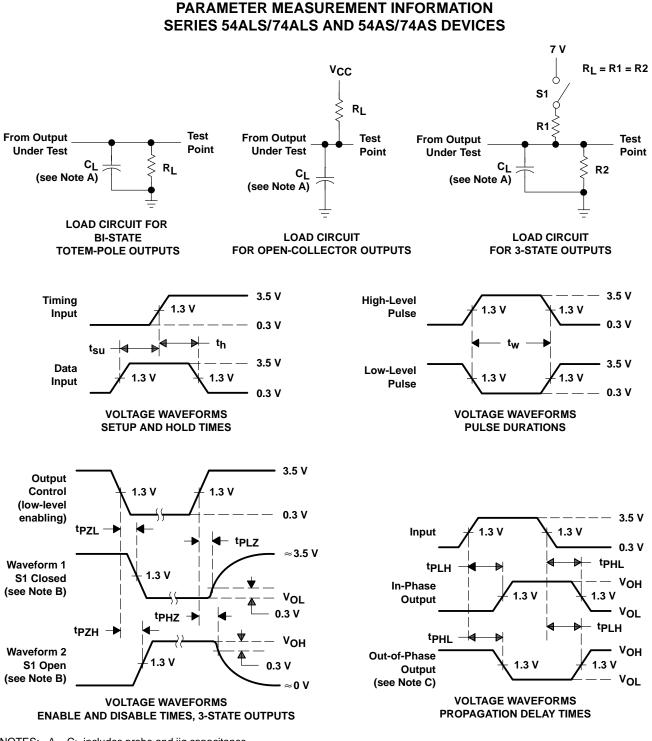
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL R1 R2	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = MIN to MAX§					
			SN54AS	SN74AS	6240A				
			MIN	MAX	MIN	MAX			
^t PLH	A	Y	1	7	1	6.5			
^t PHL	А	Ŷ	1.2	6.5	1.2	6.5	ns		
^t PZH	OE	v	1	7	1	6.4	ns		
^t PZL	OE	Ŷ	1.1	9.5	1.1	9	115		
^t PHZ	OE	V	1.2	5.5	1.2	5	ns		
^t PLZ	UE	T	1.5	12.5	1.5	9.5	115		

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_f = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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